I am the o	w-named inventor, I hereby original, first, and sole invented the subject matter which METHOD OF MANUFA	entor (if on is claimed	ily one name is listed to and for which a patent	pelow) or an original, fi is sought on the inven-	rst, and joir tion entitled	nt inventor (if plural nan A SEMICONDUCIO	nes are listed
	is attached here	to.					
			_, as application Seria	I No, and	was amende	ed on(i	f applicable).
amendment 37 CFR 1 listed belo	nt referred to above, and 1.56(a). I hereby claim prow and have also identified n(s) in which priority is contact.	acknowledg iority benef I below any	ge a duty to disclose in its under 35 U.S.C. §1	formation which is mat 19 based on any foreign	erial to the on application	examination of this appl i(s) for patent or invento	r's certificate
	FOI	REIGN AI	PLICATION(S), IF	ANY, REFERRED	TO ABOV	/E	
	COUNTRY APP		ICATION NO.	DATE		PRIORITY CLAIMED	
	JAPAN		-116322	April 18, 1997		YES X NO	
						YES NO _	
						YES NO _	
niernatio	nal filing date of this application. SERIAL NUMBER		FILING DATE		STATUS		
A. Amer RN 24,5 Franklin the Pater	appoint Elliott I. Pollock, rnick, RN 24,852; Stanley 10; Martin Abramson, RN , RN 37,134, my attorney nt and Trademark Office	B. Green, N 25,787; Cos with full properties to the connected to the conne	RN 24,351; Richard Viceorge R. Pettit, RN 27 power of substitution a herewith.	Wiener, RN 18,741; To 7,369; Louis Woo, RN 3 nd revocation, to prosec	ownsend M. 31,730; Elzi cute this app	Belser, Jr., RN 22,956 bieta Chlopecka, RN 32, blication and to transact	; Morris Liss. ,767; and Eric
	all communications to Po						a true These
statemen	ments made herein of my its were made with the kr 8 U.S.C. 1001 and may jo	owledge th	at willful false stateme	ents and the like so mad	le are punis	hable by fine, imprison:	nent, or both.
Note:	Please sign one full given name and your surname, using initials where appropriate for other names. It is important that the name be consistent throughout the application papers. Signing of an application more than five weeks prior to filing or an undated application is not acceptable to the Patent and Trademark Office except for receiving an initial filing date.						
1.	Full name of inventor Full		mitaka SUGAYA			Date: <u>March</u> 3, 1998	
	Inventor's signature Residence Citizenship Post Office Address C/O NIPPON STEEL Chiyoda-ku, Tokyo				5-3, Ote		
2.	Full name of inventor		Date:				
	Inventor's signature Residence Citizenship						
	Post Office Address		 				

^[] See additional page for additional inventors, if checked.